

DESCRIPTION

STATEK's miniature CX1HGSM AT crystals in leadless ceramic packages are designed for surface mounting on printed circuit boards or hybrid substrates. These rugged crystals are designed for applications requiring exceptional shock and vibration survival.

FEATURES

- High shock and vibration resistance
- Designed for surface mount applications using infrared, vapor phase, or epoxy mount techniques
- Low profile hermetically sealed ceramic package
- Available with glass or ceramic lid
- Custom designs available
- Full military testing available
- Designed and manufactured in the USA

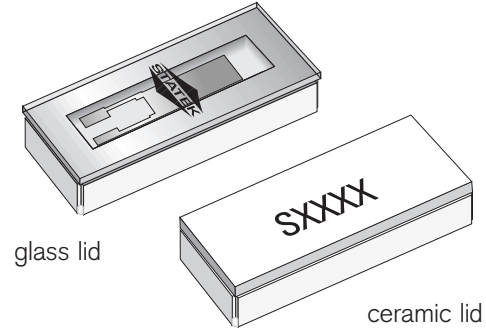
APPLICATIONS

Industrial

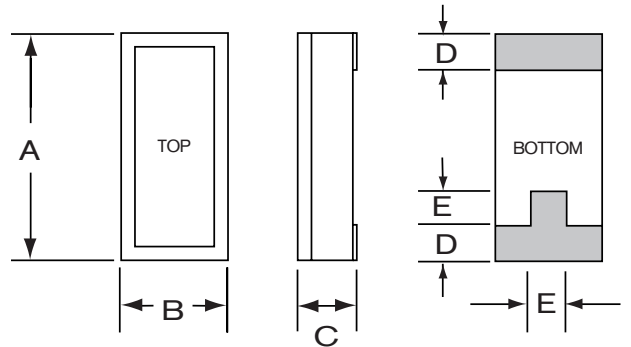
- Down-hole Data Recorder
- Process Control
- Environmental Control
- Engine Control
- Telemetry
- Ruggedized Instrumentation
- Automotive Control

Military & Aerospace

- Smart Munitions
- Timing Devices (Fuzes)
- Surveillance Devices
- Missile Telemetry
- Ruggedized Communications
- Aviation Equipment



PACKAGE DIMENSIONS



DIM	TYPICAL		MAXIMUM	
	inches	mm	inches	mm
A	0.315	8.00	0.330	8.38
B	0.140	3.56	0.155	3.94
C	-	-	see below	
D	0.045	1.14	0.055	1.40
E	0.060	1.52	0.070	1.78

THICKNESS (DIM C) MAXIMUM

	GLASS LID		CERAMIC LID	
	inches	mm	inches	mm
SM1	0.065	1.65	0.070	1.78
SM2/SM4	0.067	1.70	0.072	1.83
SM3/SM5	0.070	1.78	0.075	1.90